



# logic controller, Modicon M221, 40 IO, relay, Ethernet

TM221CE40R

### Main

Range of product	Modicon M221	
Product or component type	Logic controller	
[Us] rated supply voltage	100240 V AC	
Discrete input number	24, discrete input conforming to IEC 61131-2 Type 1	
Analogue input number	2 at 010 V	
Discrete output type	Relay normally open	
Discrete output number	16 relay	
Discrete output voltage	5125 V DC 5250 V AC	
Discrete output current	2 A	

## Complementary

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Discrete I/O number	40	
Maximum number of I/O expansion module	7 (local I/O-Architecture) 14 (remote I/O-Architecture)	
Supply voltage limits	85264 V	
Network frequency	50/60 Hz	
Inrush current	40 A	
Maximum power consumption in VA	70 VA at 100240 V with max number of I/O expansion module 41 VA at 100240 V without I/O expansion module	
Power supply output current	0.52 A 5 V for expansion bus 0.24 A 24 V for expansion bus	
Discrete input logic	Sink or source (positive/negative)	
Discrete input voltage	24 V	
Discrete input voltage type	DC	
Analogue input resolution	10 bits	
LSB value	10 mV	
Conversion time	1 ms per channel + 1 controller cycle time for analogue input analog input	
Permitted overload on inputs	+/- 30 V DC for 5 min (maximum) for analog input +/- 13 V DC (permanent) for analog input	
Voltage state 1 guaranteed	>= 15 V for input	
Voltage state 0 guaranteed	<= 5 V for input	
Discrete input current	7 mA for discrete input 5 mA for fast input	

Input impedance	3.4 kOhm for discrete input	
	100 kOhm for analog input 4.9 kOhm for fast input	
	4.9 KOHIII 101 Tast IIIput	
Response time	35 µs turn-off, I2I5 terminal(s) for input	
	10 ms turn-on for output 10 ms turn-off for output	
	5 μs turn-on, I0, I1, I6, I7 terminal(s) for fast input	
	35 μs turn-on, other terminals terminal(s) for input	
	5 μs turn-off, I0, I1, I6, I7 terminal(s) for fast input	
	100 μs turn-off, other terminals terminal(s) for input	
Configurable filtering time	0 ms for input	
	3 ms for input 12 ms for input	
	12 IIIS 101 IIIPUt	
Output voltage limits	125 V DC	
	277 V AC	
Maximum current per output common	7 A	
Absolute accuracy error	+/- 1 % of full scale for analog input	
Electrical durability	100000 cycles AC-12, 120 V, 240 VA, resistive	
	100000 cycles AC-12, 240 V, 480 VA, resistive	
	300000 cycles AC-12, 120 V, 80 VA, resistive 300000 cycles AC-12, 240 V, 160 VA, resistive	
	100000 cycles AC-15, cos phi = 0.35, 120 V, 60 VA, inductive	
	100000 cycles AC-15, cos phi = 0.35, 240 V, 120 VA, inductive	
	300000 cycles AC-15, cos phi = 0.35, 120 V, 18 VA, inductive	
	300000 cycles AC-15, cos phi = 0.35, 240 V, 36 VA, inductive	
	100000 cycles AC-14, cos phi = 0.7, 120 V, 120 VA, inductive 100000 cycles AC-14, cos phi = 0.7, 240 V, 240 VA, inductive	
	300000 cycles AC-14, cos phi = 0.7, 240 V, 36 VA, inductive	
	300000 cycles AC-14, cos phi = 0.7, 240 V, 72 VA, inductive	
	100000 cycles DC-12, 24 V, 48 W, resistive	
	300000 cycles DC-12, 24 V, 16 W, resistive 100000 cycles DC-13, 24 V, 24 W, inductive (L/R = 7 ms)	
	300000 cycles DC-13, 24 V, 7.2 W, inductive (L/R = 7 ms)	
Switching frequency	20 switching operations/minute with maximum load	
	20000000 cycles for relay output	
Mechanical durability	20000000 cycles for relay output	
Mechanical durability  Minimum load	20000000 cycles for relay output  1 mA at 5 V DC for relay output	
Minimum load	1 mA at 5 V DC for relay output	
Minimum load Protection type	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s	
Minimum load  Protection type  Reset time	1 mA at 5 V DC for relay output  Without protection at 5 A	
Minimum load  Protection type  Reset time	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions	
Minimum load  Protection type  Reset time  Memory capacity	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type  Backup time	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data  2 GB SD card (optional)	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type  Backup time  Execution time for 1 KInstruction	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data 2 GB SD card (optional)  BR2032 or CR2032X lithium non-rechargeable 1 year at 25 °C (by interruption of power supply)  0.3 ms for event and periodic task	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type  Backup time  Execution time for 1 KInstruction  Execution time per instruction	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data 2 GB SD card (optional)  BR2032 or CR2032X lithium non-rechargeable  1 year at 25 °C (by interruption of power supply)  0.3 ms for event and periodic task  0.2 μs Boolean	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type  Backup time  Execution time for 1 KInstruction  Execution time per instruction  Exct time for event task	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data  2 GB SD card (optional)  BR2032 or CR2032X lithium non-rechargeable  1 year at 25 °C (by interruption of power supply)  0.3 ms for event and periodic task  0.2 μs Boolean  60 μs response time	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type  Backup time  Execution time for 1 KInstruction  Execution time per instruction	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data  2 GB SD card (optional)  BR2032 or CR2032X lithium non-rechargeable  1 year at 25 °C (by interruption of power supply)  0.3 ms for event and periodic task  0.2 µs Boolean  60 µs response time  8000 %MW memory words	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type  Backup time  Execution time for 1 KInstruction  Execution time per instruction  Exct time for event task	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data  2 GB SD card (optional)  BR2032 or CR2032X lithium non-rechargeable  1 year at 25 °C (by interruption of power supply)  0.3 ms for event and periodic task  0.2 μs Boolean  60 μs response time	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type  Backup time  Execution time for 1 KInstruction  Execution time per instruction  Exct time for event task	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data  2 GB SD card (optional)  BR2032 or CR2032X lithium non-rechargeable  1 year at 25 °C (by interruption of power supply)  0.3 ms for event and periodic task  0.2 μs Boolean  60 μs response time  8000 %MW memory words 255 %TM timers	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type  Backup time  Execution time for 1 KInstruction  Execution time per instruction  Exct time for event task	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data  2 GB SD card (optional)  BR2032 or CR2032X lithium non-rechargeable  1 year at 25 °C (by interruption of power supply)  0.3 ms for event and periodic task  0.2 µs Boolean  60 µs response time  8000 %MW memory words 255 %TM timers 512 %KW constant words	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type  Backup time  Execution time for 1 KInstruction  Execution time per instruction  Exct time for event task	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data  2 GB SD card (optional)  BR2032 or CR2032X lithium non-rechargeable  1 year at 25 °C (by interruption of power supply)  0.3 ms for event and periodic task  0.2 µs Boolean  60 µs response time  8000 %MW memory words 255 %TM timers 512 %KW constant words 255 %C counters	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type  Backup time  Execution time for 1 KInstruction  Execution time per instruction  Exct time for event task  Maximum size of object areas	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data  2 GB SD card (optional)  BR2032 or CR2032X lithium non-rechargeable  1 year at 25 °C (by interruption of power supply)  0.3 ms for event and periodic task  0.2 μs Boolean  60 μs response time  8000 %MW memory words 255 %TM timers 512 %KW constant words 255 %C counters 512 %M memory bits	
Minimum load  Protection type  Reset time  Memory capacity  Data backed up  Data storage equipment  Battery type  Backup time  Execution time for 1 KInstruction  Execution time per instruction  Exct time for event task  Maximum size of object areas	1 mA at 5 V DC for relay output  Without protection at 5 A  1 s  256 kB for user application and data RAM with 10000 instructions 256 kB for internal variables RAM  256 kB built-in flash memory for backup of application and data 2 GB SD card (optional)  BR2032 or CR2032X lithium non-rechargeable  1 year at 25 °C (by interruption of power supply)  0.3 ms for event and periodic task  0.2 μs Boolean  60 μs response time  8000 %MW memory words 255 %TM timers 512 %KW constant words 255 %C counters 512 %M memory bits  With	

counter function	Single phase A/B Pulse/direction	
Integrated connection type	USB port with mini B USB 2.0 connector  Non isolated serial link serial 1 with RJ45 connector and RS232/RS485 interface  Ethernet with RJ45 connector	
Supply	(serial)serial link supply: 5 V, <200 mA	
Transmission rate	1.2115.2 kbit/s (115.2 kbit/s by default) for bus length of 15 m for RS485 1.2115.2 kbit/s (115.2 kbit/s by default) for bus length of 3 m for RS232 480 Mbit/s for USB	
Communication port protocol	USB port: USB - SoMachine-Network Non isolated serial link: Modbus master/slave - RTU/ASCII or SoMachine-Network Ethernet	
Port Ethernet	10BASE-T/100BASE-TX 1 port with 100 m copper cable	
communication service	DHCP client Modbus TCP client Ethernet/IP adapter Modbus TCP server Modbus TCP slave device	
Local signalling	1 LED (green) for PWR 1 LED (green) for RUN 1 LED (red) for module error (ERR) 1 LED (green) for SD card access (SD) 1 LED (red) for BAT 1 LED per channel (green) for I/O state 1 LED (green) for SL Ethernet network activity (green) for ACT Ethernet network link (yellow) for Link (Link Status)	
Electrical connection	removable screw terminal block for inputs removable screw terminal block for outputs terminal block, 3 terminal(s) for connecting the 24 V DC power supply connector, 4 terminal(s) for analogue inputs Mini B USB 2.0 connector for a programming terminal	
Maximum cable distance between devices	Shielded cable: <10 m for fast input Unshielded cable: <30 m for output Unshielded cable: <30 m for digital input Unshielded cable: <1 m for analog input	
Insulation	Between input and internal logic at 500 V AC Non-insulated between analogue input and internal logic Non-insulated between analogue inputs Between supply and ground at 1500 V AC Between sensor power supply and ground at 500 V AC Between input and ground at 500 V AC Between output and ground at 1500 V AC Between supply and internal logic at 2300 V AC Between sensor power supply and internal logic at 500 V AC Between output and internal logic at 2300 V AC Between Ethernet terminal and internal logic at 500 V AC Between supply and sensor power supply at 2300 V AC	
marking	CE	
Sensor power supply	24 V DC at 250 mA supplied by the controller	
Mounting support	Top hat type TH35-15 rail conforming to IEC 60715 Top hat type TH35-7.5 rail conforming to IEC 60715 plate or panel with fixing kit	
Height	90 mm	
Depth	70 mm	
Width	160 mm	
Net weight	0.456 kg	

## **Environment**

Standards	IEC 61131-2 UL 508 CAN/CSA C22.2 No. 213 IACS E10	
	ANSI/ISA 12-12-01	
product certifications	DNV-GL EAC ABS cULus LR RCM CE UKCA cULus HazLoc	
Environmental characteristic	Ordinary and hazardous location	
Resistance to electrostatic discharge	8 kV in air conforming to IEC 61000-4-2 4 kV on contact conforming to IEC 61000-4-2	
Resistance to electromagnetic fields	10 V/m 80 MHz1 GHz conforming to IEC 61000-4-3 3 V/m 1.4 GHz2 GHz conforming to IEC 61000-4-3 1 V/m 22.7 GHz conforming to IEC 61000-4-3	
Resistance to magnetic fields	30 A/m 50/60 Hz conforming to IEC 61000-4-8	
Resistance to fast transients	2 kV (power lines) conforming to IEC 61000-4-4 2 kV (relay output) conforming to IEC 61000-4-4 1 kV (I/O) conforming to IEC 61000-4-4 1 kV (Ethernet line) conforming to IEC 61000-4-4 1 kV (serial link) conforming to IEC 61000-4-4	
Surge withstand	2 kV power lines (AC) common mode conforming to IEC 61000-4-5 2 kV relay output common mode conforming to IEC 61000-4-5 1 kV I/O common mode conforming to IEC 61000-4-5 1 kV shielded cable common mode conforming to IEC 61000-4-5 0.5 kV power lines (DC) differential mode conforming to IEC 61000-4-5 1 kV power lines (AC) differential mode conforming to IEC 61000-4-5 1 kV relay output differential mode conforming to IEC 61000-4-5 0.5 kV power lines (DC) common mode conforming to IEC 61000-4-5	
Resistance to conducted disturbances	10 V 0.1580 MHz conforming to IEC 61000-4-6 3 V 0.180 MHz conforming to Marine specification (LR, ABS, DNV, GL) 10 V spot frequency (2, 3, 4, 6.2, 8.2, 12.6, 16.5, 18.8, 22, 25 MHz) conforming to Marine specification (LR, ABS, DNV, GL)	
Electromagnetic emission	Conducted emissions - test level: 79 dBμV/m QP/66 dBμV/m AV ( power lines (AC)) at 0.150.5 MHz conforming to IEC 55011 Conducted emissions - test level: 73 dBμV/m QP/60 dBμV/m AV ( power lines (AC)) at 0.5300 MHz conforming to IEC 55011 Conducted emissions - test level: 12069 dBμV/m QP ( power lines) at 10150 kHz conforming to IEC 55011 Conducted emissions - test level: 63 dBμV/m QP ( power lines) at 1.530 MHz conforming to IEC 55011 Radiated emissions - test level: 40 dBμV/m QP class A ( 10 m) at 30230 MHz conforming to IEC 55011 Conducted emissions - test level: 7963 dBμV/m QP ( power lines) at 1501500 kHz conforming to IEC 55011 Radiated emissions - test level: 47 dBμV/m QP class A ( 10 m) at 2001000 MHz conforming to IEC 55011	
Immunity to microbreaks	10 ms	
Ambient air temperature for operation	-1055 °C (horizontal installation) -1035 °C (vertical installation)	
Ambient air temperature for storage	-2570 °C	
Relative humidity	1095 %, without condensation (in operation) 1095 %, without condensation (in storage)	
IP degree of protection	IP20 with protective cover in place	
Pollution degree	<= 2	
Operating altitude	02000 m	
Storage altitude	03000 m	

Vibration resistance	3.5 mm at 58.4 Hz on symmetrical rail 3.5 mm at 58.4 Hz on panel mounting 1 gn at 8.4150 Hz on symmetrical rail 1 gn at 8.4150 Hz on panel mounting
Shock resistance	98 m/s² for 11 ms

## **Packing Units**

•	
Unit Type of Package 1	PCE
Number of Units in Package 1	1
Package 1 Height	11.09 cm
Package 1 Width	14.183 cm
Package 1 Length	21.085 cm
Package 1 Weight	830.0 g
Unit Type of Package 2	CAR
Number of Units in Package 2	12
Package 2 Height	29.2 cm
Package 2 Width	39.8 cm
Package 2 Length	57.9 cm
Package 2 Weight	11.04 kg
Unit Type of Package 3	P12
Number of Units in Package 3	144
Package 3 Height	105.0 cm
Package 3 Width	120.0 cm
Package 3 Length	80.0 cm
Package 3 Weight	145 kg



**Green Premium**<sup>TM</sup> **label** is Schneider Electric's commitment to delivering products with best-inclass environmental performance. Green Premium promises compliance with the latest regulations, transparency on environmental impacts, as well as circular and low-CO<sub>2</sub> products.

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Transparency RoHS/REACh

### Well-being performance

	Mercury Free	
<b>⊘</b>	Rohs Exemption Information	Yes
<b>⊘</b>	Pvc Free	

#### **Certifications & Standards**

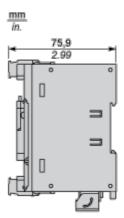
Circularity Profile	End of Life Information	
Weee	The product must be disposed on European Union markets following specific waste collection and never end up in rubbish bins	
<b>Environmental Disclosure</b>	Product Environmental Profile	
China Rohs Regulation	China RoHS declaration	
Eu Rohs Directive	Pro-active compliance (Product out of EU RoHS legal scope)	
Reach Regulation	REACh Declaration	

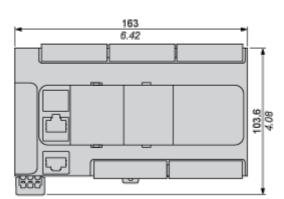
## **Product datasheet**

## **TM221CE40R**

## **Dimensions Drawings**

#### **Dimensions**



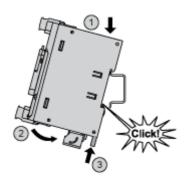


## **Product datasheet**

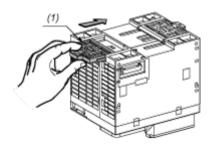
## **TM221CE40R**

Mounting and Clearance

Mounting on a Rail

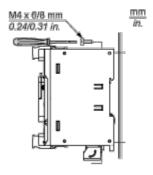


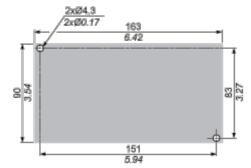
#### **Direct Mounting on a Panel Surface**



(1) Install a mounting strip

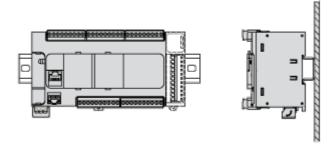
### **Mounting Hole Layout**



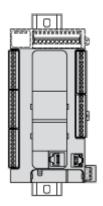


#### **Mounting**

#### **Correct Mounting Position**

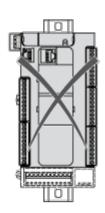


## **Acceptable Mounting Position**



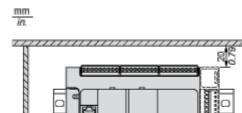
### **Incorrect Mounting Position**

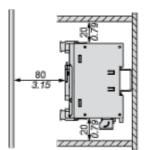






#### Clearance

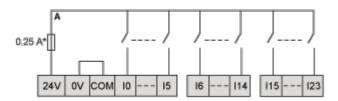




#### Connections and Schema

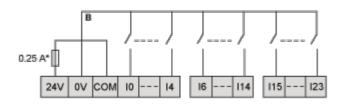
#### **Digital Inputs**

#### Wiring Diagram (Positive Logic)



(\*) Type T fuse

#### Wiring Diagram (Negative Logic)



(\*) Type T fuse

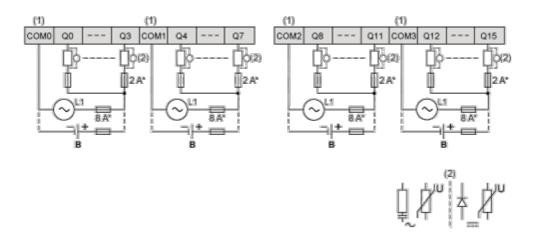
#### **Connection of the Fast Inputs**



10, 11, 16, 17

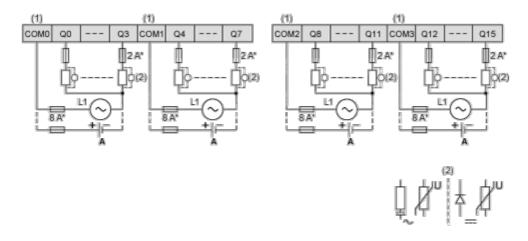
#### **Relay Outputs**

#### Negative Logic (Sink)



- (\*) Type T fuse
- (1) The COM0, COM1, COM2 and COM3 terminals are not connected internally.
- (2) To improve the life time of the contacts, and to protect from potential inductive load damage, you must connect a free wheeling diode in parallel to each inductive DC load or an RC snubber in parallel of each inductive AC load
- B Sink wiring (negative logic)

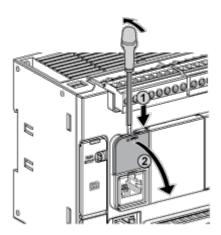
#### Positive Logic (Source)

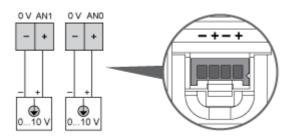


- (\*) Type T fuse
- (1) The COM0, COM1, COM2 and COM3 terminals are not connected internally.
- (2) To improve the life time of the contacts, and to protect from potential inductive load damage, you must connect a free wheeling diode in parallel to each inductive DC load or an RC snubber in parallel of each inductive AC load
- A Source wiring (positive logic)

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#### **Analog Inputs**





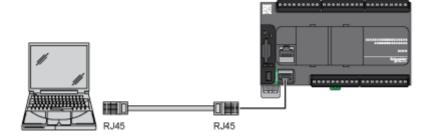
The (-) poles are connected internally.

Pin	Wire Color
0 V	Black
AN1	Red
0 V	Black
AN0	Red

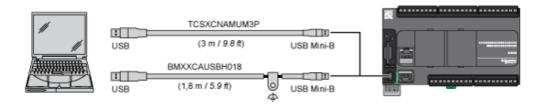
### **Ethernet Connection**



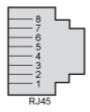
Pin N°	Signal
1	TD+
2	TD-
3	RD+
4	-
5	-
6	RD-
7	-
8	-



#### **USB Mini-B Connection**



#### **SL1 Connection**

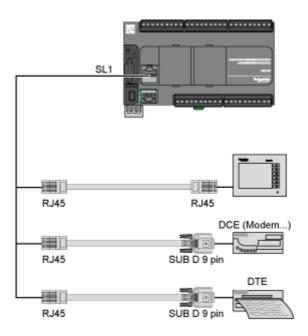


SL1

Ν°	RS 232	RS 485
1	RxD	N.C.
2	TxD	N.C.
3	RTS	N.C.
4	N.C.	D1
5	N.C.	D0
6	стѕ	N.C.
7	N.C*.	5 Vdc
8	Common	Common

N.C.: not connected

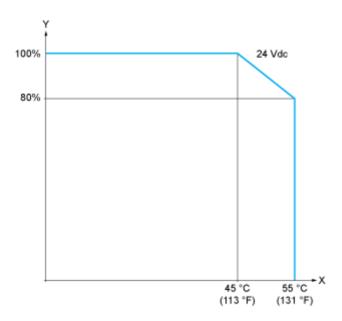
 $<sup>\</sup>ensuremath{^*}$  : 5 Vdc delivered by the controller. Do not connect.



#### Performance Curves

### **Derating Curves**

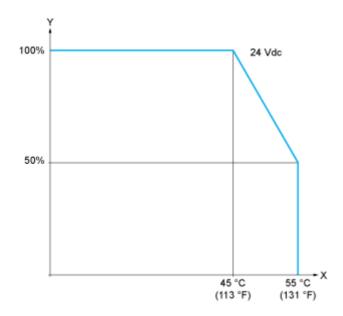
#### **Embedded Digital Inputs (No Cartridge)**



X: Ambient temperature

Y: Input simultaneous ON ratio

### **Embedded Digital Inputs (with Cartridge)**



X: Ambient temperature

Y: Input simultaneous ON ratio